

Forward Looking Statements



Factors that could cause actual events or results to differ materially from those described in this conference call include, but are not limited to, the effect of the Covid-19 pandemic on the Company's business; general business and economic conditions and the state of the semiconductor industry; market acceptance and competitiveness of the driver and non-driver products developed by the Company; demand for end-use applications products; reliance on a small group of principal customers; the uncertainty of continued success in technological innovations; our ability to develop and protect our intellectual property; pricing pressures including declines in average selling prices; changes in customer order patterns; changes in estimated full-year effective tax rate; shortage in supply of key components; changes in environmental laws and regulations; changes in export license regulated by Export Administration Regulations (EAR); exchange rate fluctuations; regulatory approvals for further investments in our subsidiaries; our ability to collect accounts receivable and manage inventory and other risks described from time to time in the Company's SEC filings, including those risks identified in the section entitled "Risk Factors" in its Form 20-F for the year ended December 31, 2020 filed with the SEC, as may be amended. Images of devices depicted in this presentation may be representative of those in which Himax has specification, or for reference-only and may not be associated with actual bill-of-material or design-win in the displayed image. Any association of such, without a confirmed disclosure of such by the Company or the Company's customer are coincidental. Himax is under strict customer disclosure guidelines on the release of such information.

Recognized Industry Leader



For the last 30 years, we have worked with leading OEMs to develop the most recognized imaging and human interfacing technologies.

1990s

Founder B.S. Wu pioneers flat panel technologies at Chimei Electronics as CTO

2000s

Chairman Wu establishes Himax to meet DDIC demand for large panels and fastgrowing medium and small panels

2010s

Himax gains market share with design wins with leading technology products companies, worldwide

2015 and Beyond

Himax leads WLO shipment and development with North American OEM customer, 3D sensing for Android, LCOS advancements for AR & HUD, CMOS for Notebook and Webcam, and WLO integration keep Himax at the forefront of AR/VR product design and pending product releases. Smart Sensing for Edge Al





















Corporate Timeline

June 2001 Himax Taiwan formed by B.S. Wu 2003

October 2004 focus on LCOS

Formed Himax Display to microdisplay technology

2004

March 2006

2006

Himax IPOs on Nasdag. Raised \$147M with Morgan Stanley

2007

2009 GFC reduced sales ~\$900 million to ~\$700 million. Refocused effort on nondriver products

2010

June 2013 Himax completed taking out financing of Chimei

2012

September 2015 AR business hit

inflection point with pilot production shipment made to a major US customer

2015

August 2016 Started expansion

for next generation LCOS and WLO production lines

OEMs. WLO shipment

2H 2018

with smartphone

2018

TDDI ramped

2020

Tablet TDDI started MP in Q1. Strong growth from products including TDDI for Smartphone and Tablets as well as

2020

Automotive drivers

2001 2002

December 2003 Himax Taiwan began trading on Emerging Stock Board (TW) under "3222"

August 2005

2005

Himax Taiwan delisted from **Emerging Stock** Board

February 2007

Himax acquired Wisepal, and forms Himax Semiconductor to focus on small and medium sized DDICs

2008

2009

2010 - 2012

2011

Non-driver sales increased gross margins and sales opportunities

July 2013

2013

2014

Signed investment agreement with Google

2016

2016

Volume shipment of AR related LCOS and WLO, AMOLED DDIC, and in-cell TDDI

2017

2017

Qualcomm & Himax jointly announced structured lightbased 3D depth sensing solution

2H 2020

2019

WiseEye, our edge Al solution, adopted by Google TensorFlow Lite for micro controllers. More joint efforts with Al allies including Edge Impulse and SparkFun

March 2021

2021

WF-I Plus AloT Platform received Microsoft Azure IoT PnP Certification. WiseEve received sizable PO for mainstream application, Shipment from 4Q21

Investment Highlights



Leading Imaging and Human Interfacing Technology Innovator

- Global display driver player with a wide range of display technologies for panels of all sizes
- Thousands of patents for Himax's IP and designs
- Imaging technology and human interfacing total-solution provider

Diversified Base of Customers and Revenues

- DDIC market share leader
- Penetration throughout all display market segments and with a leading position in several segments, including automotive
- Diversified revenues from traditional large and small/medium DDICs to TDDI, Timing controller, WLO, 3D Sensing, CIS,
 Smart Sensing and LCOS microdisplays
- Top-tier partnerships with major U.S. and Asian AP platform providers, device makers, and the world's biggest tech names
- Expect non-driver product lines to improve corporate profit margin

Operational and Public Market Performances

- Long-term profitability potential with no fund raising since IPO
- Focus on delivering P&L improvement by executing on the technologies Himax already developed for both driver IC and non-driver IC areas
- Committed to high dividend payout ratio

Innovative New Products Capturing Growth Markets

- TDDI and AMOLED technologies fuel growth for core display driver ICs business
- Our leading specifications and continuous design-wins for WLO, 3D sensing, AoS CIS, ultralow power Smart Sensing, LCoS microdisplay, all position Himax at the forefront of new product development for future product releases covering Structured Light & ToF, AR/VR, Medical Devices, Robotics, AloT, Edge AI, Smart Home, Automotive LiDAR, AR-HUD applications

Visionary Management Team

Himax on NASDAQ



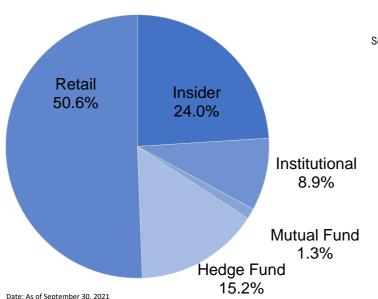
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HIMX Nasdaq Listed

Fiscal Year	December 31
Last-Traded Price (11/3/21)	\$10.88
Diluted Weighted Ave. Out. ADS	174.7M
Equivalent ADS Out	174.3M
Market Capitalization (11/3/21)	\$1,894M
Average Volume	3.01M
Insider Ownership*	24.0%

^{*} Insider ownership includes executives and board members

Shareholder Type



12 Month Trading Chart



Source: https://www.nasdaq.com/symbol/himx/stock-chart

Analysts

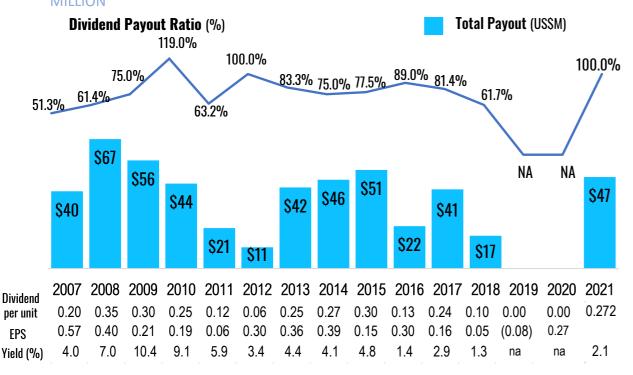
Credit Suisse	Jerry Su
Mizuho Securities Asia Ltd.	Kevin Wang
Nomura Securities	Donnie Teng
Baird Equity Research	Tristan Gerra
Vertical Group	Jonathan Lopez

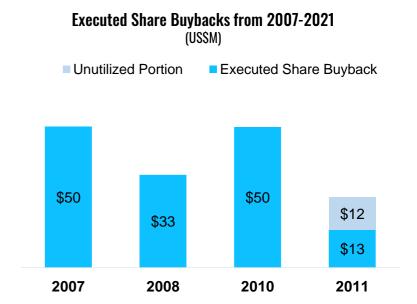
Date: As of September 30, 2021

History of Dividend and Share Buyback



\$651 HAS BEEN RETURNED TO SHAREHOLDERS INCLUDING DIVIDENDS AND SHARE BUYBACKS SINCE IPO





Himax Dividend and Policy

- Distributed a total of \$505 million of cash dividend since IPO
- Dividends referenced primarily on prior year's profitability and cash demand for future growth
- Typically pays out annual cash dividend at approximately the middle of the current calendar year, e.g., 2021 dividend payouts in July was for fiscal year 2020
- 2021 high dividend payout ratio reflected the confidence we have in our ability to execute on strategic growth initiatives, strong financial position for 2021 and overall long-term growth prospect

Himax Share Buyback

- Initiated four share buyback programs totaling \$158 million since 2007
- Repurchased a total of 46.5 million ADSs as of 2012 at average purchase price per ADS: \$3.15
- Note: On 11/30/2018 Himax chairman announced share purchase plan. Chairman Dr. Biing-Seng Wu intended to use his personal funds to purchase up to approximately \$5 million of the Company's American Depositary Shares ("ADSs") in the open market, subject to market conditions and other factors

Q3 Summary and Q4 Guidance



	302021	202021	302020	YoY	QoQ
Revenues	\$420.9M	\$365.3M	\$239.9M	+75.4%	+15.2%
Non-IFRS Gross Margin (%)	51.7%	47.5%	22.4%	+29.3%	+4.2%
Non-IFRS Profit	\$138.9M	\$109.1M	\$12.6M	+1,003.2% +	
Non-IFRS Earnings per ADS	\$0.795	\$0.624	\$0.073	+995.3%	+27.4%
IFRS Profit	\$118.7M	\$108.9M	\$8.5M	+1,304.8%	+9.0%
IFRS Earnings per ADS	\$0.680	\$0.623	\$0.049	+1,294.7%	+9.0%
9M21 YTD			9M20 YTD	YoY	
Revenues	\$1,095.2M	\$1,095.2M		+79.1%	
Non-IFRS Gross Margin (%)	47.1%			+25.0%	
Non-IFRS Profit	\$315.1M		\$18.1M	+1,640.0%	
Non-IFRS Earnings per ADS	\$1.803		\$0.105	+1,624.6%	
IFRS Profit	\$294.5M		\$13.1M	+2,143.3%	
IFRS Earnings per ADS	\$1.685		\$0.076	+2,123.6%	

402021 Guidance

Revenues	Increase by 4% to 8% sequentially
Non-IFRS Gross Margin (%)	Around 50%, depending on our final product mix
Non-IFRS Profit	To be around 78.0 cents to 83.0 cents
IFRS Profit	To be around 74.5 cents to 79.5 cents

A Gløbal Semiconductor Company



- Fabless semiconductor company with world leading visual imaging processing technologies
- Global market leader in TFT-LCD display driver and timing controller ICs
- 200+ customers across Taiwan, China, Japan, Korea, U.S. and Europe
- 3,021 patents granted and 498 patents pending approval worldwide as of September 30, 2021
- NASDAQ-listed since March 2006 (HIMX)
- Around 2,000 employees worldwide; more than 90% are engineers
- Headquartered in Tainan, Taiwan with 9 R&D centers in Taiwan, China, Korea, Israel and U.S., out of a total of 24 offices across Taiwan, China, Japan, Korea, Israel and U.S.

Himax's Global Reach



HEADQUARTERS Tainan, Taiwan

Corporate Structure



Nasdaq Listed

Himax Technologies, Inc.

Himax Technologies, LTD.

- TFT-LCD Drivers, EPD Drivers, Micro LED Drivers and AMOLED Drivers
- TCON and Bridge IC
- Touch Controllers
- Pure in-cell Touch (TDDI)
- AloT Edge Al Processors
- 3D Decoder Processors
- ASIC Service and IP Licensing
- Power Management ICs, P-Gamma OP, Level Shifter and LED Driver
- Wafer Level Optics and 3D Sensing Modules
- In-house Color Filter Fab for LCoS and CIS

Himax Display, Inc.

- LCoS Modules for Head-Mounted Display, Head-up Display and Pico-projector Applications
- Phase Modulation for Communication, Holographic Displays and AR-HUD
- Light Guide

Himax Imaging, LTD.

- CMOS Image Sensors
- Ultralow Power Always-on (AOS) CMOS Image Sensors

































Display Driver IC (DDIC)





We are a leader in display driver ICs used to enable large, small and medium-sized flat panel displays in TFT and Touch

MARKETS WE SERVE

Smartphones, Tablets, Automotive, Monitors, Notebooks, TVs, Gaming, Education, Industrial, Healthcare plus 100's more applications that use all types of flat panel displays

In what devices can you find Himax DDIC technologies

















Who uses Himax DDICs





















Japan Display Inc.

















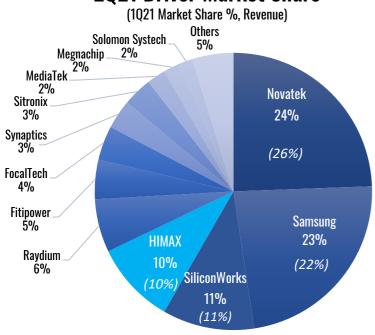




Our DDIC Market Share



2021 Driver Market Share

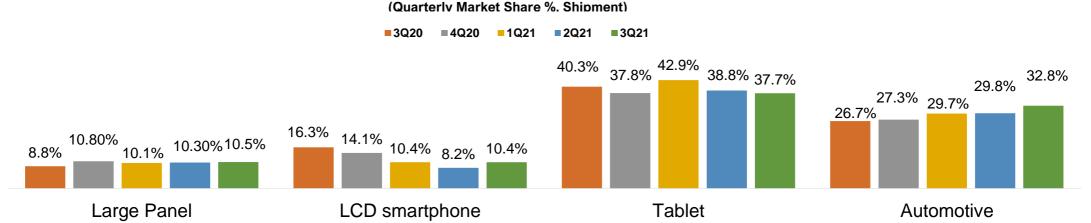


We provide a complete solution of image processing technologies and leverage our expertise in TV, Monitor, NB, mobile devices, automotive and other mass-market technology releases

- Large display driver IC business positions toward high end 8K/4K TV, gaming monitor and low power NB
- Strong market share in fastest moving consumer devices including tablet and automotive application
- Major TDDI design-wins and shipments for smartphones, tablets and automotive well executed backed in 2020 and continues to accelerate into 2022

Source: Omdia and company estimates (This covers TFT-LCD and OLED DDICs)

HIMX's Strong Driver IC Market Share in Mass Market Devices



TDDI Technologies





We provide technologies for touch sensor displays including in-cell touch and the fast-growing segment of Touch and Display Driver Integration (TDDI) single-chips

MARKETS WE SERVE

Beginning with smartphones, expanded to tablets, automotive, and many other consumer electronic devices

- Smartphone: LCD TDDI widely adopted for entry & mid-range smartphones with penetration >70% and rapidly replacing traditional DDIC
- Tablet: New in-cell TDDI refreshed tablet life cycle starting 1Q20.
 Himax, the primary supplier for non-iOS tablet tier-1 customers, expects continuous growth throughout 2021
- Automotive: Q2'2019 MP. TDDI is selected by many leading tier-1 and OEMs for their upcoming first launches of new vehicles. Shipped over 1M automotive TDDI chips within 3Q21 alone. Expect exponential growth in 2022

In what devices can you find Himax TDDI technologies



A-Si HD+ Smartphone





LTPS FHD+ and HD+ Smartphone



8" and Large-sized Tablets, In-cell TDDI



Tablet PC & Smart Speaker



Auto CID & Infotainment

Who uses Himax Touch and TDDI Technologies

















WLO and 3D Sensing





We offer industry leading WLO design know-how and mass production expertise in structured light and ToF. Himax 3D sensing offers SLiM total solution with leading depth perception feature and key components, 3D decoder IC, to reach out diversified end applications

MARKETS WE SERVE

Wafer Level Optics (WLO):

- DOE, diffuser, lens and other nanoimprinting diffractive optics for structured light, ToF and others. Accelerating new design activities of ToF projectors in world-facing ToF 3D sensing camera for smartphone
- Waveguide for AR and LCoS. Lens for CIS

3D Sensing:

 e-payment, smart door lock, automotive, access control, medical inspection, service robot and industrial robotics

In what applications can you find Himax WLO and 3D Sensing













3D Ecosystem Partners









Others

Ultralow Power Smart Sensing and CIS















Head motion box

Al Ecosystem Partners



















ECO LUX

Himax Smart Sensing brings computer vision Al to edge devices with extremely low power. We participated tier-1 edge-to-cloud ecosystems for broad market access. Himax CMOS image sensors include RGB, near infrared (NIR) and ultralow power Always-on Sensor (AoS)

MARKETS WE SERVE

Smart Sensing:

NB, smart tripod, battery security camera, automotive, panoramic video conferencing, utilities meter, QR code reader, doorbell, door lock, smart buildings, manufacturing, retail, agriculture

CIS:

- Ultralow power AoS: Best for IoT/smart sensing in human/ occupancy detection, eye tracking & gesture control
- NIR: 3D sensing and smart sensing
- **RGB**: NB and web camera

In what applications can you find Himax 3D/Smart Sensing technologies





















LCoS Microdisplays





We are the leader and long-term innovator of Liquid Crystal on Silicon (LCoS) displays and one of the companies capable of high-volume production runs of LCoS displays for the launch of mass-market devices

Front-Lit LCoS Technology Advantages

- Compact form factor, brightness, power efficiency
- Simpler optical engine design and lower cost



MARKETS WE SERVE

LCoS and Front-Lit LCoS

 Industrial, consumer, shopping, search, gaming, sports, pico projector, AR/VR smart glasses, automotive head-up displays, Tier-1 OEM's market leading AR glasses

Phase Modulation and Beam Steering

Holographic display, AR-HUD, WSS, ADAS and LiDAR

Who uses Himax LCoS micro display technologies











Our Customers



DISPLAY DRIVERS































CMOS IMAGE SENSORS

SONY FOXCONN

Others



















🕒 LG Innotek 🖽



SAMSUNG OPPO



LUMOTIVE

LCOS

MICRODISPLAYS



Optinuent









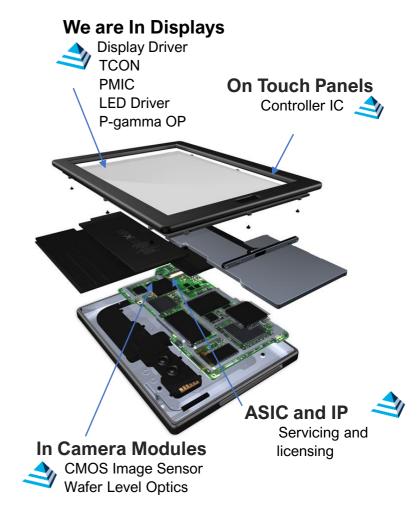


POWER MANAGEMENT IC & LED DRIVERS



TIMING CONTROLLERS







In AR Devices LCOS, WLO





In VR Devices



Fabless Manufacturing Expertise











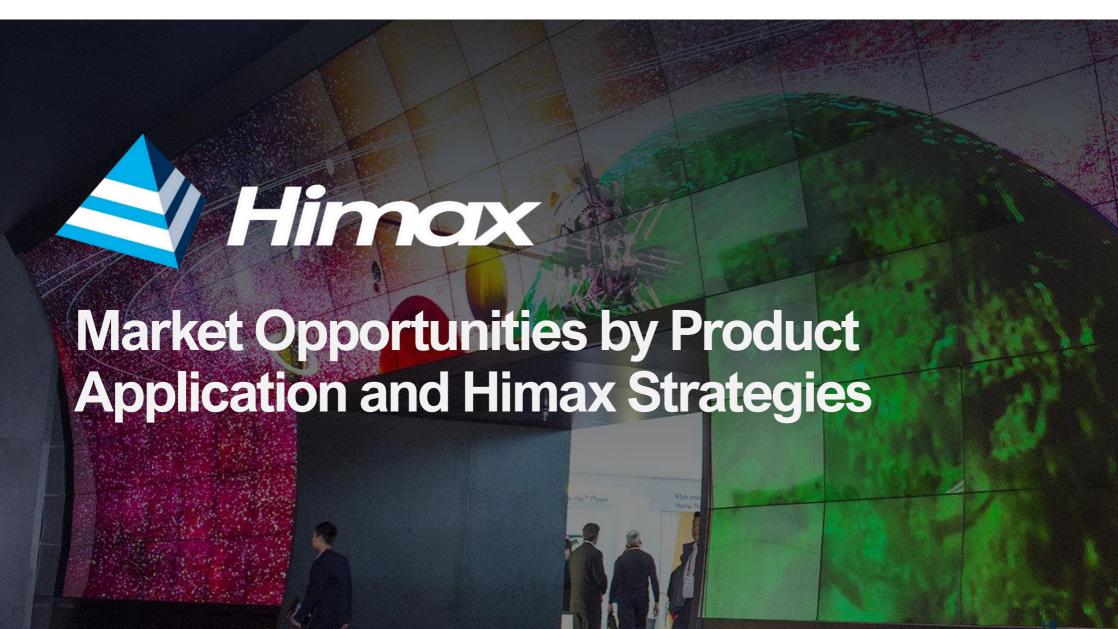














Market Trends

- Expect higher TDDI penetration in tablet and auto going forward
- TDDI fits in consumer demand for slimmer devices
- Higher penetration of TDDI is refreshing smartphone /tablet/ automotive life cycle, creating higher dollar content and margin
- Panel features, size and quantity inside the car are increasing, driving higher demand of TDDI for automotive

Himax Strategies and Market Position

TDDI pure in-cell solution

- Numerous new design-wins and shipment with top-tier tablet and smartphone makers started 4Q19
- TDDI is the biggest growth driver for Himax from 2020. Amid semiconductor capacity shortage, we strategically favor high margin product segments such as tablet and automotive as we are the main or sole supplier to customers
- In-cell TDDI is becoming mainstream for non-iOS tablet, where Himax is the primary source. Mass production started for major Tier-1 OEMs since 1Q20, with robust growth from 2020 and throughout 2021
- Himax tablet TDDI with active stylus feature is well penetrated into new designs for accurate handwriting and painting. TDDI with active stylus feature represented over 30% of tablet TDDI sales in 3Q21
- Himax dominates automotive TDDI technology with mass production experience and advanced specification for leading panel makers. Shipped over 1M automotive TDDI chips within 3Q21 alone. Expect exponential growth in 2022
- Product migration and new TDDI product development towards higher performance, ultra slim bezel and higher resolution feature

Global Smartphone TDDI Demand Forecast 2019-2025

(Omdia, 2021)



TDDI Technology Enables OEMs to Manufacture Thinner, Better and Less Expensive Phones



Display Driver IC (DDIC)



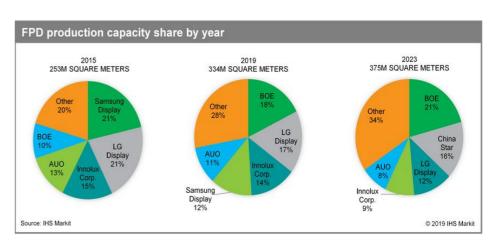
Market Trends

- Chinese panel makers, benefited from Korean fab restructuring and increased their global market share, will procure more volume from Taiwan DDIC supply chain
- Leading Chinese panel makers' shipments continue to dominate the market. China ranked the No. 1 position with its total TFT-LCD capacity
- 4K TV penetration accelerates; 8K TV started to emerge
- Demand for IT panel (monitor and NB) surged in 2020 due to the pandemic
- Demands for more sophisticated and higher performing displays are rising in the automotive segment

Himax Strategies and Market Position

- · Leading market share of large DDIC in China
- Major beneficiary of Industry and Korean fab restructuring which will increase Chinese panel maker's global market share
- Increased shipments of 4K solutions. Collaborate with major panel makers on the development of next generation 8K TVs. 8K TV is a strategic area for Himax as it represents a high barrier of entry for late comers and much more IC and Tcon used per device
- Leader in higher frame rate and low power solution in high end gaming monitor and NB market
- Not only DDIC, Himax also provides comprehensive TCON lineups for a total solution to meet demands of high resolution, high frame rate and low power display

China Takes a Leading Role in Display Panel Manufacturing and DDIC Demand



WLO and 3D Sensing



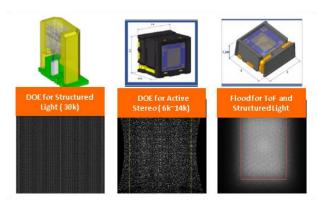
Market Trends

- Wafer-Level Optics (WLO) remains the best technology for structured light, Time-of-Flight (ToF) related 3D sensing
- Very few companies can provide advanced WLO solutions to achieve optical high efficiency, small form factors, and eye safety regulations for consumer devices
- 3D sensing is expected to be widely adopted by smartphones, AR/VR, e-payment and access control, etc.

Himax Strategies and Market Position

- WLO: Exceptional design know-how and mass production expertise. We deliver consistent product quality and high yields for WLO anchor customer's large-scale adoption since 2015 with continuous shipment
- Continue to participate the most advanced 3D sensing projects covering structured light for non-smartphone applications and ToF for smartphone
- Collaborating with tier-1 laser and sensor partners to develop new world-facing 3D sensing camera for tier-1 OEM whereby we provide optical components and/or projectors, which are critical for the performance of the whole ToF solution
- Offer market leading 3D decoder ASIC to customers who wish to design their own structured light 3D sensing solution. Good achievement in epayment engagement in China. Welcomed by 3D industry in areas where privacy is of importance
- In non-smartphone, working with industry-leading facial recognition algorithm and application processor partners to develop new 3D sensing application for business access control, medical inspection, etc
- 3D sensing will be the growth opportunity for Himax beyond 2021

Himax WLO for 3D Sensing



Wafer Level Process **Integrated Optics High Accuracy**



WLO for 3D ToF / Structured Light



Ultralow Power Smart Sensing and CIS



Market Trends

- Smart Al devices demand boosted, but very few companies can provide ultralow power solutions in vision Al in the area of human detection, people tracking, people counting, and gesture control
- Adoption for Al-based, ultralow power smart sensing solution is expected to be wider in 2021 for AloT applications, including smart home, smart building, and devices for agriculture, industrial, healthcare and retail purposes

Himax Strategies and Market Position

- Himax Ultralow Power CMOS Image Sensor (CIS):
 - Industry first ultralow power and low latency back-illuminated CIS solution for always on, intelligent visual sensing
 - Our CIS includes near infrared (NIR) sensors for 3D sensing and ultralow power computer vision Always-on-Sensor (AoS). Good for smart building and security applications, next generation NB, and AR/VR for mobile devices
 - Support ggHD/QVGA/VGA AoS and industrial first 2-in-1 RGB/NIR/AI sensor
 - Reference design win for Google TensorFlow Lite
- Himax Smart Sensing:
 - WiseEye total solution: Composed by industry leading AoS, Al processor and TinyML Al algorithm. Meet strong demands for edge Al devices with features of ultralow power. Optimize computer vision-based total solutions in applications such as NB, air conditioner, battery camera, door lock, doorbell and many other. In 1Q21, received sizable orders for mainstream application from an existing global client and will enter into production in 4Q21. More design-ins in areas such as smart meter, smart tripod, battery camera and panoramic video conference from global leading brands. Some of them are slated for shipment from 4Q21
 - Key component business model: We reinforce our go-to-market strategy by intensively participating cutting-edge AI ecosystem and cloud service partners' AI infrastructure, such as Google TensorFlow Lite for Microcontrollers, Microsoft Azure, Arm AI Partner Program and tinyML Foundation

Who uses Himax CIS



Ultralow Power Sensor Applications











Best For IoT/Smart Sensing

Face/Body Detection, Eye Tracking & Gesture Control,



















EDGE IMPULSE

LCoS Microdisplays

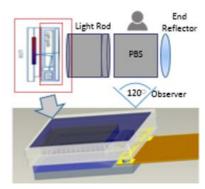
A Himax

Market Trends

- Many top name multinationals and start-ups are investing heavily to develop the AR ecosystem, including applications, software, operating systems, system electronics and optics
- Capabilities in technology know-how and scalable manufacturing are significant barriers of entry to new market entrants and existing technology companies
- Himax can provide the integrated services of R&D, joint development and manufacturing expertise

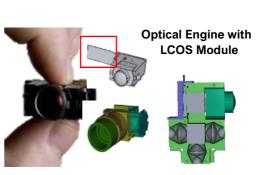
Himax Strategies and Market Position

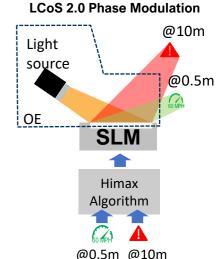
- The leader in microdisplays with patent-protected technology, inhouse facilities and shipping record of > 4M units
- Focus on AR goggle devices and HUD for automotive applications
- Customer list for AR goggle device covers many of the world's biggest tech giants. Many of whom demoed their new AR goggles at CES 2020
- LCoS is one of the mainstream technologies for AR goggle devices.
 On-going collaboration with global Tier 1 AR glasses device manufacturers since 2011
- Design-wins of high-end HUD for the automotive sector
- Introduced Phase Modulation technology for LCoS 2.0 microdisplay. Aiming holographic display for AR-HUD, LiDAR for autonomous driving or ADAS, WSS for WDM
- LCoS represents a long-term growth opportunity for Himax



Front Lit LCOS Advantages

- Compact Form Factor
- Brightness
- Power Efficiency
- MP Efficiency & Readiness









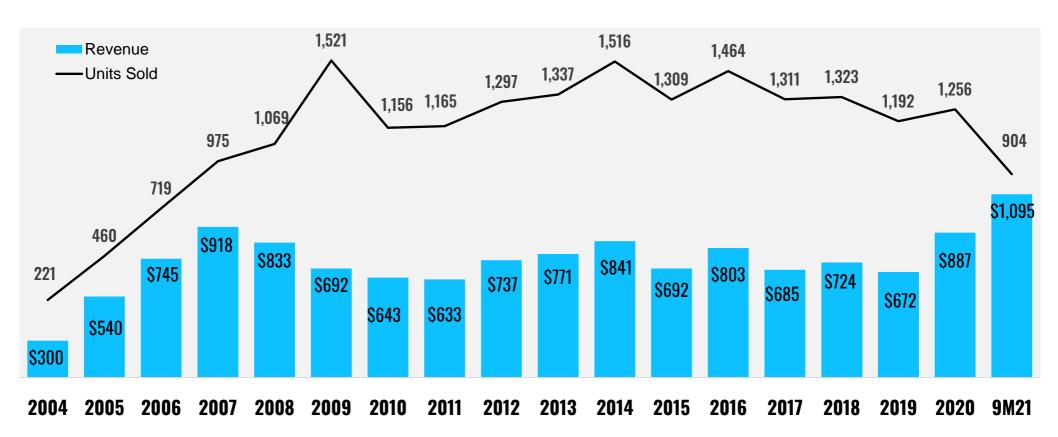


Unit and Revenue History



We are One of the Leading Semiconductor Companies in the World

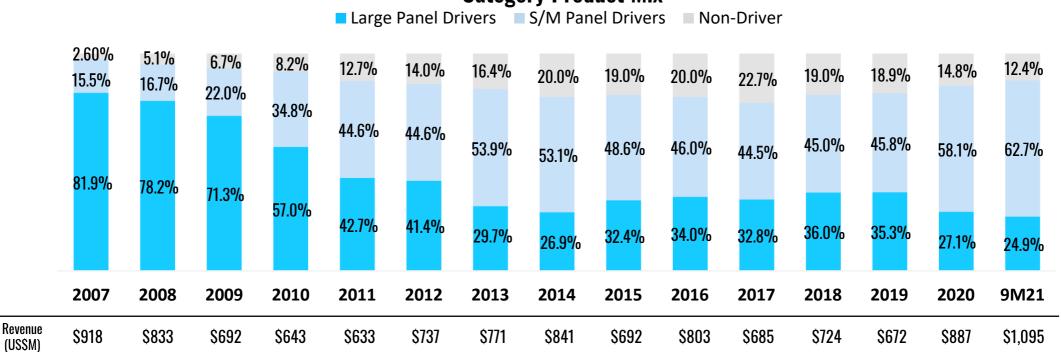
Units Sold and Revenue (in millions of units and millions of USD)



A Balanced Product Mix.



Category Product Mix



Global market leader in driver ICs for large and small & medium-sized panels

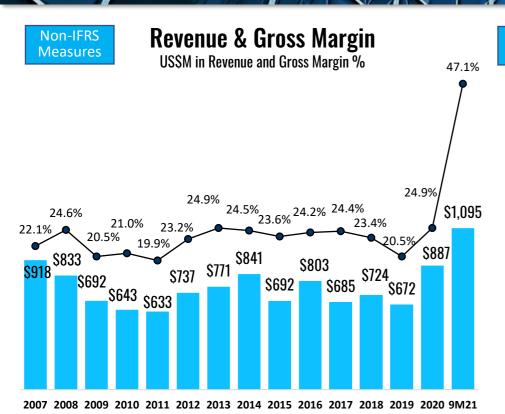
- Large display driver business positions toward high end 8K/4K TV, gaming monitor and low power NB
- Market leader in tablet TDDI with mass production from 1Q20. Strategically favoring tablet over smartphone for higher margin amid short capacity
- Continuous growth in smartphone segments with selected customers amid short
- Advantages of leading technology and mass production record in automotive driver. Expect further market share gains with major panel customers and increasing automotive TDDI adoption

Innovative technologies in advanced Tcon, Wafer Level Optics, CIS, Smart Sensing and LCOS microdisplays

- Outstanding performance in high value added Tcon area including 8K/4K TV, gaming monitor, low power notebook and automotive
- Smart sensing collaborates with global edge-Al solution partners by actively engaging edge-to-cloud platforms
- Market leader in 3D sensing for both Structured Light and TOF. 3D decoder IC well adopted in e-payment
- Enlarge LCoS microdisplayfor AR/VR, pico projector and extend to phase modulation LCoS technology for AR-HUD, LiDAR and WSS
- Top choice of global leaders to jointly develop non-driver category / optical related technologies. Enjoy diversified customer base, strengthened product portfolio and higher gross margin

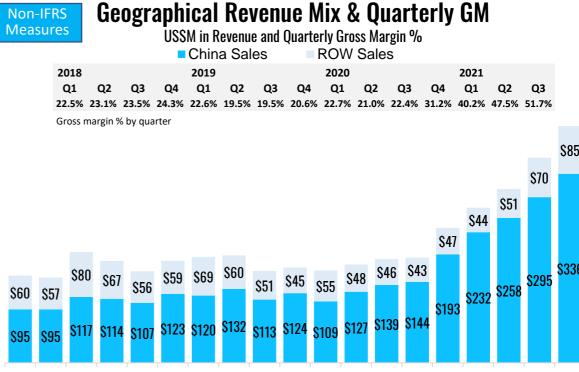
Gross Margin is a Key Business Focus





Margin improved with favorable product mix

- Revenue growth with improved gross margin in 2021 due to favorable product mix and clientele
- High margin segments supporting our long- term growth
 - Leadership in tablet: a dominate supplier with leading technology spec
 - Leadership in auto: a leading supplier with leading technology spec. Demand unfolding with a trend in electric vehicle and auto pilot. Increasing TDDI adoption
 - New revenue stream: ultralow power and always on sensor are needed for edge AI devices

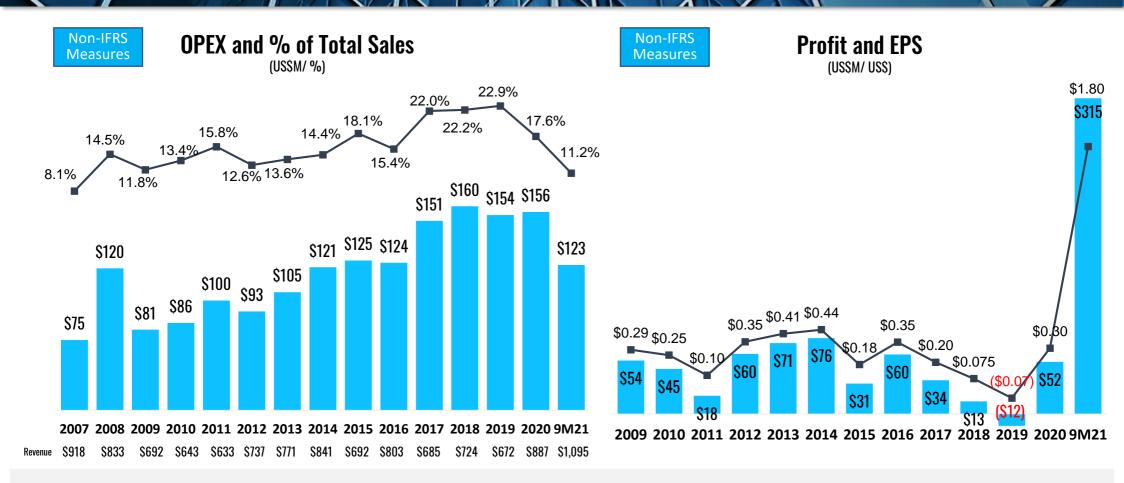


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- Improved GM in 2H vs.1H in 2017 driven by more favorable product mix, due to WLO shipments and the one-off customer reimbursements related to AR goggle device in Q3
- 2019 GM declined due to adverse product mix change
- 2020 GM increased due to a more favorable product mix and strong demand derived from the pandemic
- 1H21 GM continued to set a new high for favorable product mix amid capacity shortage
 - Strong demand for monitor and notebook due to WFH/LFH
 - Strong growth in TDDI for smartphone / tablet / automotive
 - Auto demand increase amid emerging demand for EV & autonomous driving

OPEX and the Bottom Line





- 2018 & 2019 Higher capex to meet the demands of 3D sensing total solution, projector module or optics
- 2019 Completion of the new WLO facility, including additional WLO capacity, active alignment equipment and extra office
- Continuous commitment to R&D and customer engineering for strategic area with great growth potential in the future
- 2019 Profit declined due to adverse product mix change, weaker market demand and intensified competition
- 9M21 OPEX Up 9.0% YoY. Operating expense ratio reduced from 18.5% in 9M20 to 11.2% in 9M21, reflecting our careful management over operating expenses

Performance History

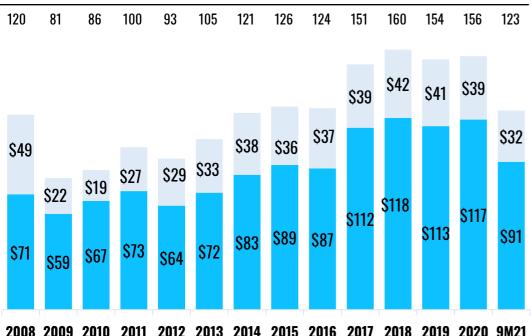




Operating and R&D Expenses (USSM)

R&D Expense Operating Expense ex. RD





- Well-manage R&D investment and expense for customer engineering for strategic growth areas including WLO, CIS, TDDI, Auto and AMOLED
- IFRS Share-based compensation and cash award from 2014 to 9M21: \$11.1mn, \$6.2mn, \$10.2mn, \$6.9mn, \$4.1mn, \$0.4mn, \$5.4mn and \$23.7mn



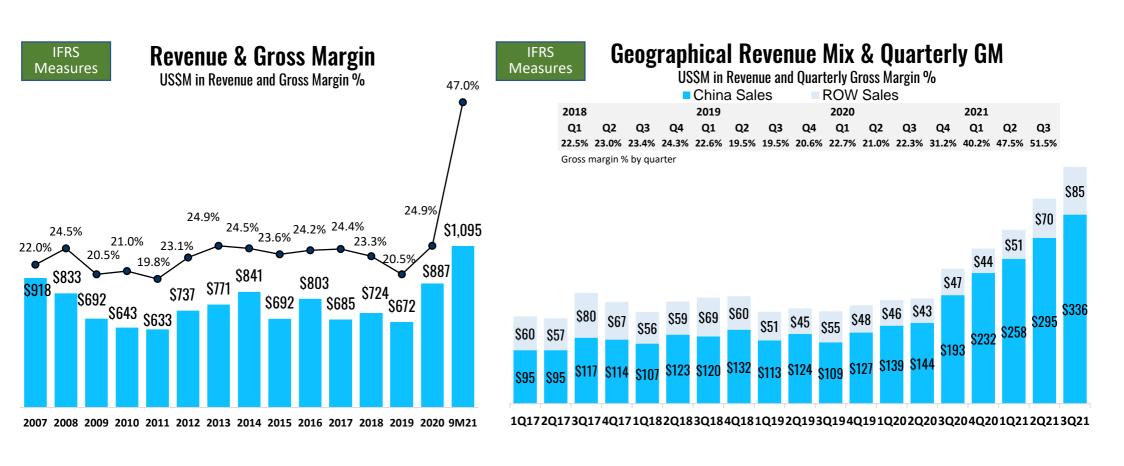
EBITDA (US\$M)



- Robust profit growth in 2016 as a result of revenue growth and GM enhancement from new product
- 2019 profit setbacks caused by lower gross margin due to adverse product mix change
- 2021 much higher GM is mainly a reflection of the tight foundry capacity which resulted in a more favorable IC pricing and product mix

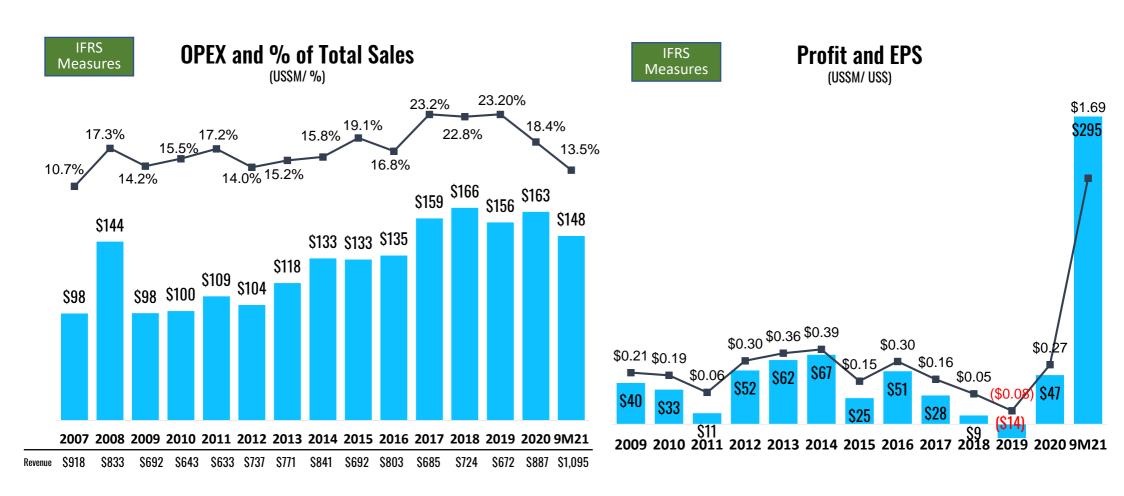
Gross Margin - IFRS





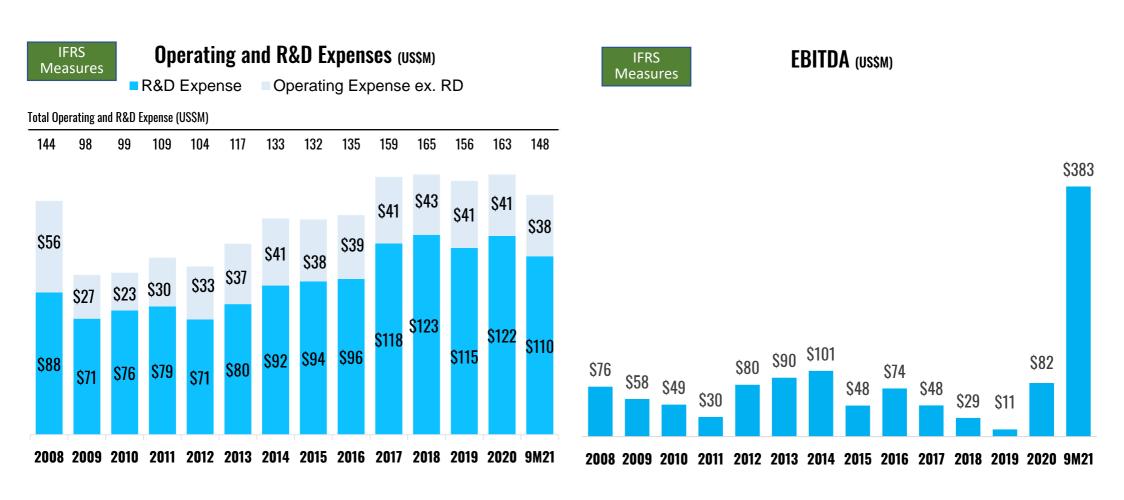
OPEX and the Bottom Line - IFRS





Perførmance History - IFRS





Income Statement



For the Fiscal Period Ended	<u>3Q-2021</u> (Unaudited)	<u>3Q-2020</u> (Unaudited)	<u>2Q-2021</u> (Unaudited)	<u>Y2020</u> (Audited)	<u>Y2019</u> (Audited)	
Revenues	\$420,938	\$239,934	\$365,261	\$887,282	\$671,835	
Cost of revenues	204,213	186,329	191,665	666,501	533,916	
Gross profit Gross margin	216,725 <i>51.5</i> %	53,605 22.3%	173,596 <i>4</i> 7.5%	220,781 24.9%	137,919 <i>20.5</i> %	
Operating expenses Research and development General and administrative Sales and marketing Total operating expenses	51,399 9,025 8,057 68,481	33,073 6,530 4,558 44,161	28,924 6,398 4,248 39,570	122,265 23,915 16,675 162,855	114,859 23,672 17,695 156,226	
Operating income (loss)	148,244	9,444	134,026	57,926	(18,307)	
Non-operating income (loss)	(15)	(260)	(754)	(1,054)	2,539	
Profit (loss) before income taxes	148,229	9,184	133,272	56,872	(15,768)	
Income tax expense Profit (loss) for the period Add: Loss attributable to noncontrolling interests	30,379 117,850 866	1,124 8,060 391	24,954 108,318 573	11,712 45,160 1,974	416 (16,184) 2,570	
Profit (loss) attributable to Himax stockholders	\$118,716	\$8,451	\$108,891	\$47,134	(\$13,614)	
Non-IFRS profit (loss) attributable to Himax stockholders	\$138,931	\$12,594	\$109,103	\$52,330	(\$12,128)	
IFRS earnings (loss) per ADS attributable to Himax stockholders (in cents)						
Basic Diluted	68.0 68.0	4.9 4.9	62.3 62.3	27.3 27.2	(7.9) (7.9)	
Non-IFRS earnings (loss) per ADS attributable to Himax stockholders (in cents) Basic 79.5 7.3 62.5 30.3 (7.0) Diluted 79.5 7.3 62.4 30.2 (7.0)						

Balance Sheet



	September 30, 2021 (Unaudited)	<u>June 30, 2021</u> (Unaudited)	September 30, 2020 (Unaudited)
<u>Assets</u>			
Current assets:			
Cash and cash equivalents	\$229,197	\$251,725	
Financial assets at amortized cost	17,861	13,542	
Financial assets at fair value through profit or loss	3,765	5,144	
Accounts receivable, net (including related parties)	400,897	329,023	221,100
Inventories	160,947	134,243	125,725
Restricted deposit	156,800	112,100	104,000
Other current assets	55,832	30,262	27,575
Total Current Assets	1,025,299	876,039	621,251
Financial assets at fair value through profit or loss	13,943	13,902	13,480
Equity method investments	3,920	4,205	3,761
Property, plant and equipment, net	133,874	137,031	135,123
Goodwill	28,138	28,138	28,138
Refundable deposits	87,001	79,154	1,273
Other assets	35,726	16,219	23,964
<u>Total Assets</u>	\$1,327,901	\$1,154,688	\$826,990
<u>Liabilities and Equity</u> Current liabilities:			
Current portion of long-term unsecured borrowings	6,000	6,000	6,000
Short-term secured borrowings*	151,400	104,000	104,000
Accounts payable (including related parties)	226,290	210,488	153,153
Income taxes payable	61,217	39,587	5,340
Other current liabilities	65,685	97,877	41,180
Total Current Liabilities	510,592	457,952	309,673
Long-term unsecured borrowings	48,000	49,500	54,000
Other liabilities	38,093	33,572	17,962
Himax stockholders' equity	728,231	609,837	442,751
Noncontrolling interest	2,985	3,827	2,604
Total Liabilities and Equity	\$1,327,901	\$1,154,688	\$826,990

^{*} Short-term secured borrowings is guaranteed by restricted deposit

Cash Flow Statement

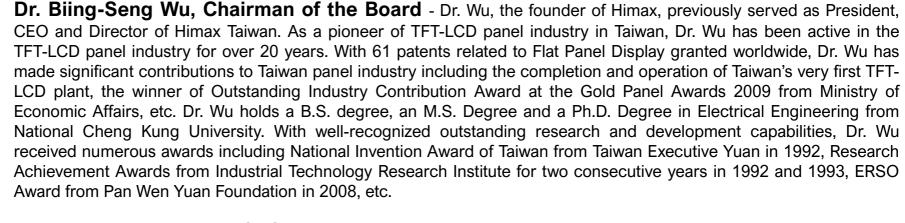


	3Q-2021	2Q-2021	2020FY	2019FY
	(Unaudited	(Unaudited	(Audited)	(Audited)
Profit (loss) for the period	<u>\$117,850</u>	<u>\$108,318</u>	<u>\$45,160</u>	<u>(\$16,184)</u>
Depreciation and amortization	5,292	5,449	23,596	24,399
Share-based compensation expenses	97	0	763	457
Finance costs	269	260	1,705	2,325
Income tax expense	30,379	24,954	11,712	416
Inventories write downs	1,224	1,646	11,919	25,447
Others	88	529	(1,284)	(5,184)
	155,199	141,156	93,571	31,676
Changes in:				
Decrease (increase) in accounts receivable (including related parties)	(71,874)	(39,927)	(78,297)	23,992
Decrease (increase) in inventories	(27,928)	(20,944)	24,772	(6,660)
Increase (decrease) in accounts payable (including related parties)	15,802	17,895	57,335	(36,180)
Others	(1,679)	(2,587)	8,675	(420)
Cash generated from operating activities	69,520	95,593	106,056	12,408
Interest received	112	317	1,066	2,060
Interest paid	(269)	(260)	(1,811)	(2,372)
Income tax paid	(8,852)	(10,453)	(2,701)	(4,440)
Net cash provided by operating activities	\$60,511	\$85,197	\$102,610	\$7,656
Acquisitions of property, plant and equipment	(2,128)	(1,398)	(5,786)	(45,922)
Acquisitions of financial assets at amortized cost	(8,384)	(2,658)	(3,829)	(4,023)
Proceeds from disposal of financial assets at amortized cost	4,009	1,025	6,735	4,171
Acquisitions of financial assets at fair value through profit or loss	0	(13,007)	(19,743)	(50,487)
Proceeds from disposal of financial assets at fair value through profit or loss	1,339	14,797	12,068	50,648
Increase in refundable deposits	(33,007)	(59,563)	(13,992)	(2,821)
Others	5,491	2,556	2,182	667
Net cash used in investing activities	(\$32,680)	(\$58,248)	(\$22,365)	(\$47,767)
Payments of cash dividends	(47,404)	(20)	(4)	0
Proceeds from short-term unsecured borrowings	0	0	208,137	244,224
Repayments of short-term unsecured borrowings	0	0	(265,355)	(207,006)
Proceeds from long-term unsecured borrowings	0	0	60,000	0
Repayments of long-term unsecured borrowings	(1,500)	(1,500)	(1,500)	0
Proceeds from short-term secured borrowings	233,200	60,000	278,000	158,000
Repayments of short-term secured borrowings	(185,800)	(60,000)	(338,000)	(158,000)
Release (pledge) of restricted deposit	(47,400)	0	60,000	0
Others	(1,347)	(1,201)	1,983	(1,957)
Net cash provided by (used in) financing activities	(\$50,251)	(\$2,721)	\$3,261	\$35,261
Effect of foreign currency exchange rate changes	(108)	119	377	(532)
Net increase (decrease) in cash and cash equivalents	(\$22,528)	\$24,347	\$83,883	<u>(\$5,382)</u>
Cash and cash equivalents at beginning of period	\$251,725	\$227,378	\$101,055	\$106,437
Cash and cash equivalents at end of period	\$229,197	\$251,725	\$184,938	\$101,055

Management Team









Jordan Wu, President, CEO and Director Mr. Jordan Wu, co-founder of Himax, previously served as the chairman of the board of Himax Taiwan from April 2003 to October 2005. Prior to joining Himax Taiwan, he served as CEO of TV Plus Technologies, Inc. and CFO and executive director of DVN Holdings Ltd. in Hong Kong. Prior to that, he was an investment banker in Hong Kong with Merrill Lynch (Asia Pacific) Limited, Barclays de Zoete Wedd (Asia) Limited and Baring Securities. Mr. Wu holds a B.S. degree in Mechanical Engineering from National Taiwan University and an M.B.A. degree from the University of Rochester.



Jessica Pan, Chief Financial Officer - Jessica joined Himax in 2006 with over 22 years of experience in finance and accounting. Jessica has played an integral role at Himax on finance, accounting, financial planning and analysis, forecasting and tax, having served as interim Chief Financial Officer from October 2010 to January 2012. Prior to joining Himax, Jessica worked as Assistant Finance Manager for Advanced Semiconductor Engineering, Inc. from 2002 to 2006 and as Auditor at Arthur Andersen LLP in Taiwan from 1998 to 2001. She holds a B.S. degree in Agriculture Chemistry from National Taiwan University and an M.B.A. degree from the State University of New York at Buffalo.



Eric Li, Chief IR/PR Officer - Joining Himax in 2012, Mr. Eric Li has extensive experience in image processing related IC design, having worked in the areas of sales, marketing, R&D and served as Associate Vice President at Himax covering the Intelligent Sensing AI product line. Mr. Li has previously worked in video processing ASIC service and TV/monitor ASSP products before he was put in charge of the fab construction and operation of Himax's WLO advanced optics operation. Prior to Himax, Mr. Eric Li served in executive positions of Cadence Design Systems, Socle Technology, Macronix International and Powerchip Semiconductor. He holds a B.S. degree in Nuclear Engineering from National Tsing Hua University and an M.S. degree in Computer Science from New Jersey Institute of Technology.



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Corporate Counsel

Baker & M!Kenzie

SEC Legal Counsel

DAVIS POLK & WARDWELL

Auditor

